

## Electronic Patent Application Fee Transmittal

<b>Application Number:</b>	10681983			
<b>Filing Date:</b>	09-Oct-2003			
<b>Title of Invention:</b>	MULTIPLE LEADFRAME LAMINATED IC PACKAGE			
<b>First Named Inventor/Applicant Name:</b>	Chun Ho Fan			
<b>Filer:</b>	Johnathan Bockman/Kathleen Libby			
<b>Attorney Docket Number:</b>	618902001410			
Filed as Large Entity				
<b>Utility under 35 USC 111(a) Filing Fees</b>				
<b>Description</b>	<b>Fee Code</b>	<b>Quantity</b>	<b>Amount</b>	<b>Sub-Total in USD(\$)</b>
<b>Basic Filing:</b>				
<b>Pages:</b>				
<b>Claims:</b>				
<b>Miscellaneous-Filing:</b>				
<b>Petition:</b>				
<b>Patent-Appeals-and-Interference:</b>				
<b>Post-Allowance-and-Post-Issuance:</b>				
Utility Appl issue fee	1501	1	1440	1440
<b>Extension-of-Time:</b>				

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
Printed copy of patent - no color	8001	6	3	18
Total in USD (\$)				1458